COP472-3

COP472-3 Liquid Crystal Display Controller



Literature Number: SNOSBQ3

National Semiconductor

July 1995

COP472-3 Liquid Crystal Display Controller

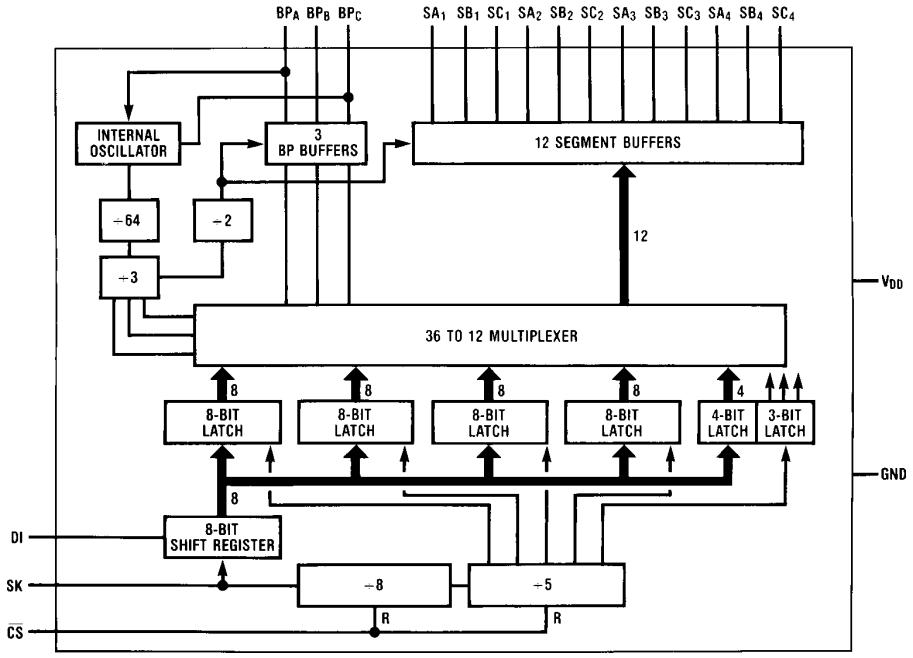
General Description

The COP472−3 Liquid Crystal Display (LCD) Controller is a peripheral member of the COPS™ family, fabricated using CMOS technology. The COP472-3 drives a multiplexed liquid crystal display directly. Data is loaded serially and is held in internal latches. The COP472-3 contains an on-chip oscillator and generates all the multi-level waveforms for backplanes and segment outputs on a triplex display. One COP472-3 can drive 36 segments multiplexed as 3 x 12 (4½ digit display). Two COP472-3 devices can be used together to drive 72 segments (3 x 24) which could be an 8½ digit display.

Features

- Direct interface to TRIPLEX LCD
- Low power dissipation (100 μW typ.)
- Low cost
- Compatible with all COPS processors
- Needs no refresh from processor
- On-chip oscillator and latches
- Expandable to longer displays
- Operates from display voltage
- MICROWIRE™ compatible serial I/O
- 20-pin Dual-In-Line package and 20-pin SO

Block Diagram



TL/DD/6932−1

COPS™ and MICROWIRE™ are trademarks of National Semiconductor Corporation.

©1996 National Semiconductor Corporation

Absolute Maximum Ratings

Voltage at CS, DI, SK pins	−0.3V to +9.5V	Storage Temperature	−65°C to +150°C
Voltage at all other Pins	−0.3V to V_{DD} +0.3V	Lead Temp. (Soldering, 10 Seconds)	300°C
Operating Temperature Range	0°C to 70°C		

DC Electrical Characteristics

GND = 0V, V_{DD} = 3.0V to 5.5V, T_A = 0°C to 70°C (depends on display characteristics)

Parameter	Conditions	Min	Max	Units
Power Supply Voltage, V_{DD}		3.0	5.5	Volts
Power Supply Current, I_{DD} (Note 1)	V_{DD} = 5.5V		250	μA
	V_{DD} = 3V		100	μA
Input Levels				
DI, SK, CS				
V_{IL}			0.8	Volts
V_{IH}		0.7 V_{DD}	9.5	Volts
BPA (as Osc. in)				
V_{IL}			0.6	Volts
V_{IH}		V_{DD} − 0.6	V_{DD}	Volts
Output Levels, BPC (as Osc. Out)				
V_{OL}			0.4	Volts
V_{OH}		V_{DD} − 0.4	V_{DD}	Volts
Backplane Outputs (BPA, BPB, BPC)				
$V_{BPA, BPB, BPC}$ ON	During	V_{DD} − ΔV	V_{DD}	Volts
$V_{BPA, BPB, BPC}$ OFF	BP+ Time	⅓ V_{DD} − ΔV	⅓ V_{DD} + ΔV	Volts
$V_{BPA, BPB, BPC}$ ON	During	0	ΔV	Volts
$V_{BPA, BPB, BPC}$ OFF	BP− Time	⅔ V_{DD} − ΔV	⅔ V_{DD} + ΔV	Volts
Segment Outputs (SA_1 ~ SA_4)				
V_{SEG} ON	During	0	ΔV	Volts
V_{SEG} OFF	BP+ Time	⅔ V_{DD} − ΔV	⅔ V_{DD} + ΔV	Volts
V_{SEG} ON	During	V_{DD} − ΔV	V_{DD}	Volts
V_{SEG} OFF	BP− Time	⅓ V_{DD} − ΔV	⅓ V_{DD} + ΔV	Volts
Internal Oscillator Frequency		15	80	kHz
Frame Time (Int. Osc. ÷ 192)		2.4	12.8	ms
Scan Frequency ($1/T_{SCAN}$)		39	208	Hz
SK Clock Frequency		4	250	kHz
SK Width		1.7		μs
DI				
Data Setup, t_{SETUP}		1.0		μs
Data Hold, t_{HOLD}		100		ns
$\overline{CS}$				
t_{SETUP}		1.0		μs
t_{HOLD}		1.0		μs
Output Loading Capacitance			100	pF

Note 1: Power supply current is measured in stand-alone mode with all outputs open and all inputs at V_{DD}.

Note 2: ΔV = 0.05V_{DD}.

Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Voltage at CS, DI, SK Pins	−0.3V to +9.5V
Voltage at All Other Pins	−0.3V to V_{DD} +0.3V
Operating Temperature Range	−40°C to +85°C
Storage Temperature	−65°C to +150°C
Lead Temperature (Soldering, 10 seconds)	300°C

DC Electrical Characteristics

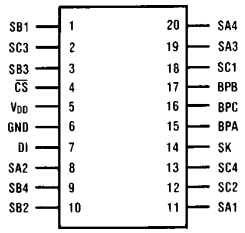
GND = 0V, V_{DD} = 3.0V to 5.5V, T_A = −40°C to +85°C (depends on display characteristics)

Parameter	Conditions	Min	Max	Units
Power Supply Voltage, V_{DD}		3.0	5.5	Volts
Power Supply Current, I_{DD} (Note 1)	V_{DD} = 5.5V		300	μA
	V_{DD} = 3V		120	μA
Input Levels				
DI, SK, CS				
V_{IL}			0.8	Volts
V_{IH}		0.7 V_{DD}	9.5	Volts
BPA (as Osc. In)				
V_{IL}			0.6	Volts
V_{IH}		V_{DD} − 0.6	V_{DD}	Volts
Output Levels, BPC (as Osc. Out)				
V_{OL}			0.4	Volts
V_{OH}		V_{DD} − 0.4	V_{DD}	Volts
Backplane Outputs (BPA, BPB, BPC)				
$V_{BPA, BPB, BPC}$ ON	During	V_{DD} − ΔV	V_{DD}	Volts
$V_{BPA, BPB, BPC}$ OFF	BP+ Time	⅓ V_{DD} − ΔV	⅓ V_{DD} + ΔV	Volts
$V_{BPA, BPB, BPC}$ ON	During	0	ΔV	Volts
$V_{BPA, BPB, BPC}$ OFF	BP− Time	⅔ V_{DD} − ΔV	⅔ V_{DD} + ΔV	Volts
Segment Outputs (SA_1 ~ SA_4)				
V_{SEG} ON	During	0	ΔV	Volts
V_{SEG} OFF	BP+ Time	⅔ V_{DD} − ΔV	⅔ V_{DD} + ΔV	Volts
V_{SEG} ON	During	V_{DD} − ΔV	V_{DD}	Volts
V_{SEG} OFF	BP− Time	⅓ V_{DD} − ΔV	⅓ V_{DD} + ΔV	Volts
Internal Oscillator Frequency		15	80	kHz
Frame Time (Int. Osc. ÷ 192)		2.4	12.8	ms
Scan Frequency ($1/T_{SCAN}$)		39	208	Hz
SK Clock Frequency		4	250	kHz
SK Width		1.7		μs
DI				
Data Setup, t_{SETUP}		1.0		μs
Data Hold, t_{HOLD}		100		ns
$\overline{CS}$				
t_{SETUP}		1.0		μs
t_{HOLD}		1.0		μs
Output Loading Capacitance			100	pF

Note 1: Power supply current is measured in stand-alone mode with all outputs open and all inputs at V_{DD}.

Note 2: ΔV = 0.05 V_{DD}.

Dual-In-Line Package



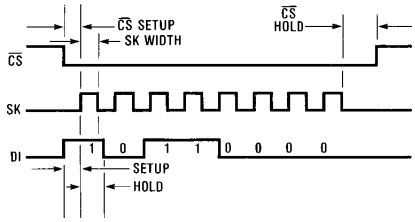
TL/DD/6932–2

Top View

Order Number COP472MW-3 or COP472N-3
See NS Package Number M20A or N20A

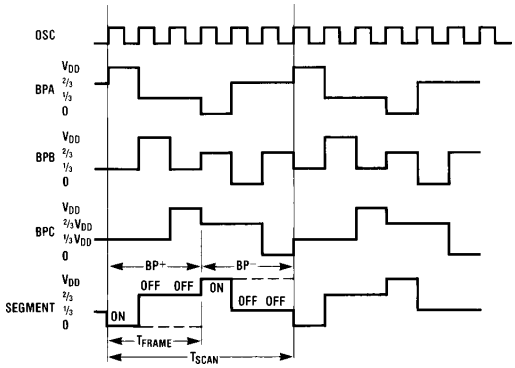
Pin	Description
$\overline{CS}$	Chip select
V_{DD}	Power supply (display voltage)
GND	Ground
DI	Serial data input
SK	Serial clock input
BP_A	Display backplane A (or oscillator in)
BP_B	Display backplane B
BP_C	Display backplane C (or oscillator out)
SA1 ~ SC4	12 multiplexed outputs

FIGURE 2. Connection Diagram



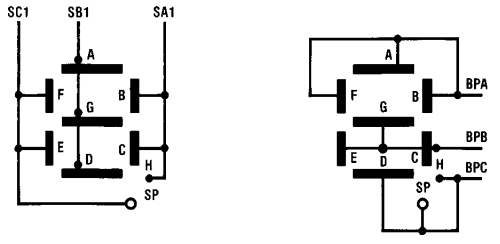
TL/DD/6932–3

FIGURE 3. Serial Load Timing Diagram



TL/DD/6932–4

FIGURE 4. Backplane and Segment Waveforms



TL/DD/6932–5

FIGURE 5. Typical Display Internal Connections
Epson LD-370

Functional Description

The COP472-3 drives 36 bits of display information organized as twelve segments and three backplanes. The COP472-3 requires 40 information bits: 36 data and 4 control. The function of each control bit is described below. Display information format is a function of the LCD interconnections. A typical segment/backplane configuration is illustrated in *Figure 5*, with this configuration the COP472-3 will drive 4 digits of 9 segments.

To adapt the COP472-3 to any LCD display configuration, the segment/backplane multiplex scheme is illustrated in Table I.

Two or more COP472-3 chips can be cascaded to drive additional segments. There is no limit to the number of COP472-3's that can be used as long as the output loading capacitance does not exceed specification.

TABLE I. COP472-3 Segment/Backplane Multiplex Scheme

Bit Number	Segment, Backplane	Data to Numeric Display	
1	SA1, BPC	SH	Digit 1
2	SB1, BPB	SG	
3	SC1, BPA	SF	
4	SC1, BPB	SE	
5	SB1, BPC	SD	
6	SA1, BPB	SC	
7	SA1, BPA	SB	
8	SB1, BPA	SA	
9	SA2, BPC	SH	Digit 2
10	SB2, BPB	SG	
11	SC2, BPA	SF	
12	SC2, BPB	SE	
13	SB2, BPC	SD	
14	SA2, BPB	SC	
15	SA2, BPA	SB	
16	SB2, BPA	SA	
17	SA3, BPC	SH	Digit 3
18	SB3, BPB	SG	
19	SC3, BPA	SF	
20	SC3, BPB	SE	
21	SB3, BPC	SD	
22	SA3, BPB	SC	
23	SA3, BPA	SB	
24	SB3, BPA	SA	
25	SA4, BPC	SH	Digit 4
26	SB4, BPB	SG	
27	SC4, BPA	SF	
28	SC4, BPB	SE	
29	SB4, BPC	SD	
30	SA4, BPB	SC	
31	SA4, BPA	SB	
32	SB4, BPA	SA	
33	SC1, BPC	SPA	Digit 1
34	SC2, BPC	SP2	Digit 2
35	SC3, BPC	SP3	Digit 3
36	SC4, BPC	SP4	Digit 4
37	not used		
38	Q6		
39	Q7		
40	SYNC		

SEGMENT DATA BITS

Data is loaded in serially, in sets of eight bits. Each set of segment data is in the following format:

SA	SB	SC	SD	SE	SF	SG	SH

Data is shifted into an eight bit shift register. The first bit of the data is for segment H, digit 1. The eighth bit is segment A, digit 1. A set of eight bits is shifted in and then loaded into the digit one latches. The second set of 8 bits is loaded into digit two latches. The third set into digit three latches, and the fourth set is loaded into digit four latches.

CONTROL BITS

The fifth set of 8 data bits contains special segment data and control data in the following format:

SYNC	Q7	Q6	X	SP4	SP3	SP2	SP1

The first four bits shifted in contain the special character segment data. The fifth bit is not used. The sixth and seventh bits program the COP472-3 as a stand alone LCD driver or as a master or slave for cascading COP472-3's. BPC of the master is connected to BPA of each slave. The following table summarizes the function of bits six and seven:

Q7	Q6	Function	BPC Output	BPA Output
1	1	Slave	Backplane Output	Oscillator Input
0	1	Stand Alone	Backplane Output	Backplane Output
1	0	Not Used	Internal Osc. Output	Oscillator Input
0	0	Master	Internal Osc. Output	Backplane Output

The eighth bit is used to synchronize two COP472-3's to drive an 8½-digit display.

LOADING SEQUENCE TO DRIVE A 4½-DIGIT DISPLAY

Steps:

1. Turn $\overline{CE}$ low.
2. Clock in 8 bits of data for digit 1.
3. Clock in 8 bits of data for digit 2.
4. Clock in 8 bits of data for digit 3.
5. Clock in 8 bits of data for digit 4.
6. Clock in 8 bits of data for special segment and control function of BPC and BPA.

0	0	1	1	SP4	SP3	SP2	SP1

7. Turn $\overline{CS}$ high.

Note: $\overline{CS}$ may be turned high after any step. For example to load only 2 digits of data, do steps 1, 2, 3, and 7.

$\overline{CS}$ must make a high to low transition before loading data in order to reset internal counters.

LOADING SEQUENCE TO DRIVE AN 8½-DIGIT DISPLAY

Two or more COP472-3's may be connected together to drive additional segments. An eight digit multiplexed display is shown in *Figure 7*. The following is the loading sequence to drive an eight digit display using two COP472-3's. The right chip is the master and the left the slave.

Steps:

1. Turn $\overline{CS}$ low on both COP472-3's.
2. Shift in 32 bits of data for the slave's four digits.
3. Shift in 4 bits of special segment data: a zero and three ones.

1	1	1	0	SP4	SP3	SP2	SP1

   This synchronizes both the chips and BPA is oscillator input. Both chips are now stopped.

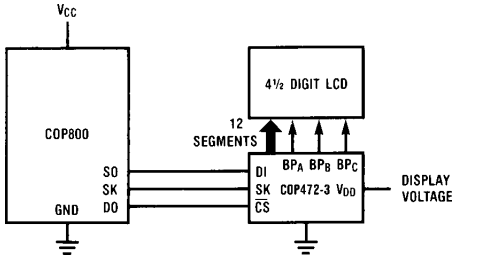
4. Turn CS high to both chips.
5. Turn CS low to master COP472-3.
6. Shift in 32 bits of data for the master's 4 digits.
7. Shift in four bits of special segment data, a one and three zeros.

0	0	0	1	SP4	SP3	SP2	SP1

   This sets the master COP472-3 to BPA as a normal backplane output and BPC as oscillator output. Now both the chips start and run off the same oscillator.

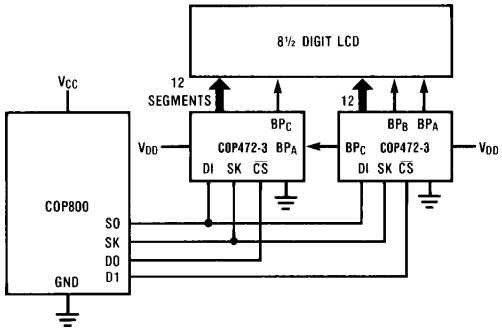
8. Turn $\overline{CS}$ high.

The chips are now synchronized and driving 8 digits of display. To load new data simply load each chip separately in the normal manner, keeping the correct status bits to each COP472-3 (0110 or 0001).



TL/DD/6932–6

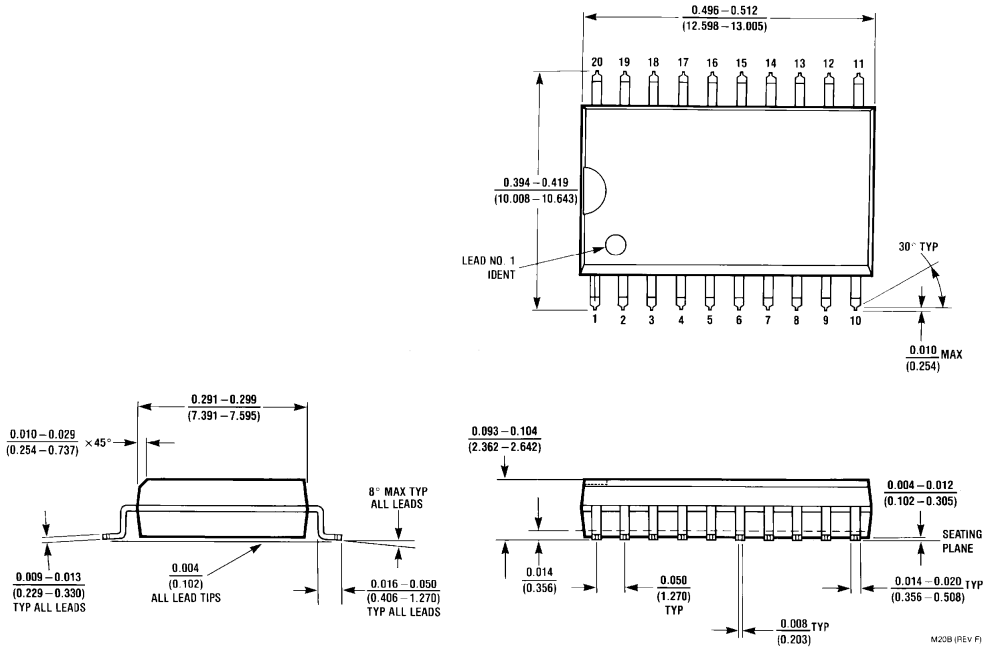
FIGURE 6. System Diagram – 4½ Digit Display



TL/DD/6932–7

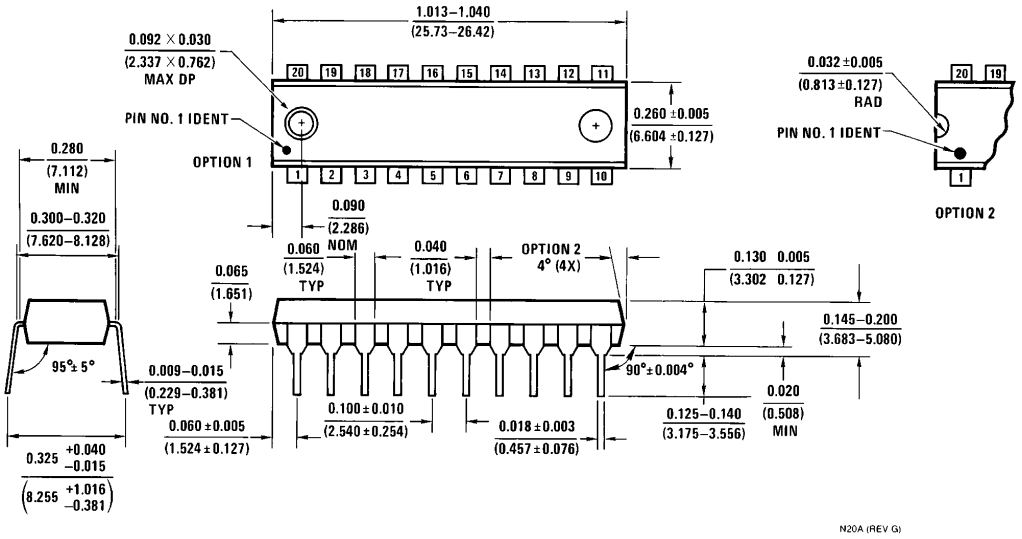
FIGURE 7. System Diagram – 8½ Digit Display

Physical Dimensions inches (millimeters) unless otherwise noted



20-Lead Molded DIP (M)
Order Number COP472MW-3
NS Package Number M20B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



20-Lead Molded DIP (N)
Order Number COP472N-3
NS Package Number N20A

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

National Semiconductor Corporation
1111 West Bardin Road
Arlington, TX 76017
Tel: 1(800) 272-9959
Fax: 1(800) 737-7018

http://www.national.com

National Semiconductor Europe
Fax: +49 (0) 180-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 180-530 85 85
English Tel: +49 (0) 180-532 78 32
Français Tel: +49 (0) 180-532 93 58
Italiano Tel: +49 (0) 180-534 16 80

National Semiconductor Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: (852) 2737-1600
Fax: (852) 2736-9960

National Semiconductor Japan Ltd.
Tel: 81-043-299-2308
Fax: 81-043-299-2408

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		**Applications**	
Audio	www.ti.com/audio	Communications and Telecom	www.ti.com/communications
Amplifiers	amplifier.ti.com	Computers and Peripherals	www.ti.com/computers
Data Converters	dataconverter.ti.com	Consumer Electronics	www.ti.com/consumer-apps
DLP® Products	www.dlp.com	Energy and Lighting	www.ti.com/energy
DSP	dsp.ti.com	Industrial	www.ti.com/industrial
Clocks and Timers	www.ti.com/clocks	Medical	www.ti.com/medical
Interface	interface.ti.com	Security	www.ti.com/security
Logic	logic.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Power Mgmt	power.ti.com	Transportation and Automotive	www.ti.com/automotive
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Mobile Processors	www.ti.com/omap		
Wireless Connectivity	www.ti.com/wirelessconnectivity		
	TI E2E Community Home Page		e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2011, Texas Instruments Incorporated

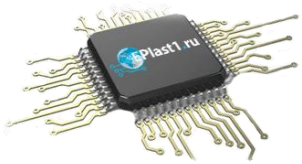
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.